

FINAL

**NASAPLANNED DEVELOPMENT PROGRAM
FOR
MICROSPACECRAFT PRODUCT ASSURANCE**

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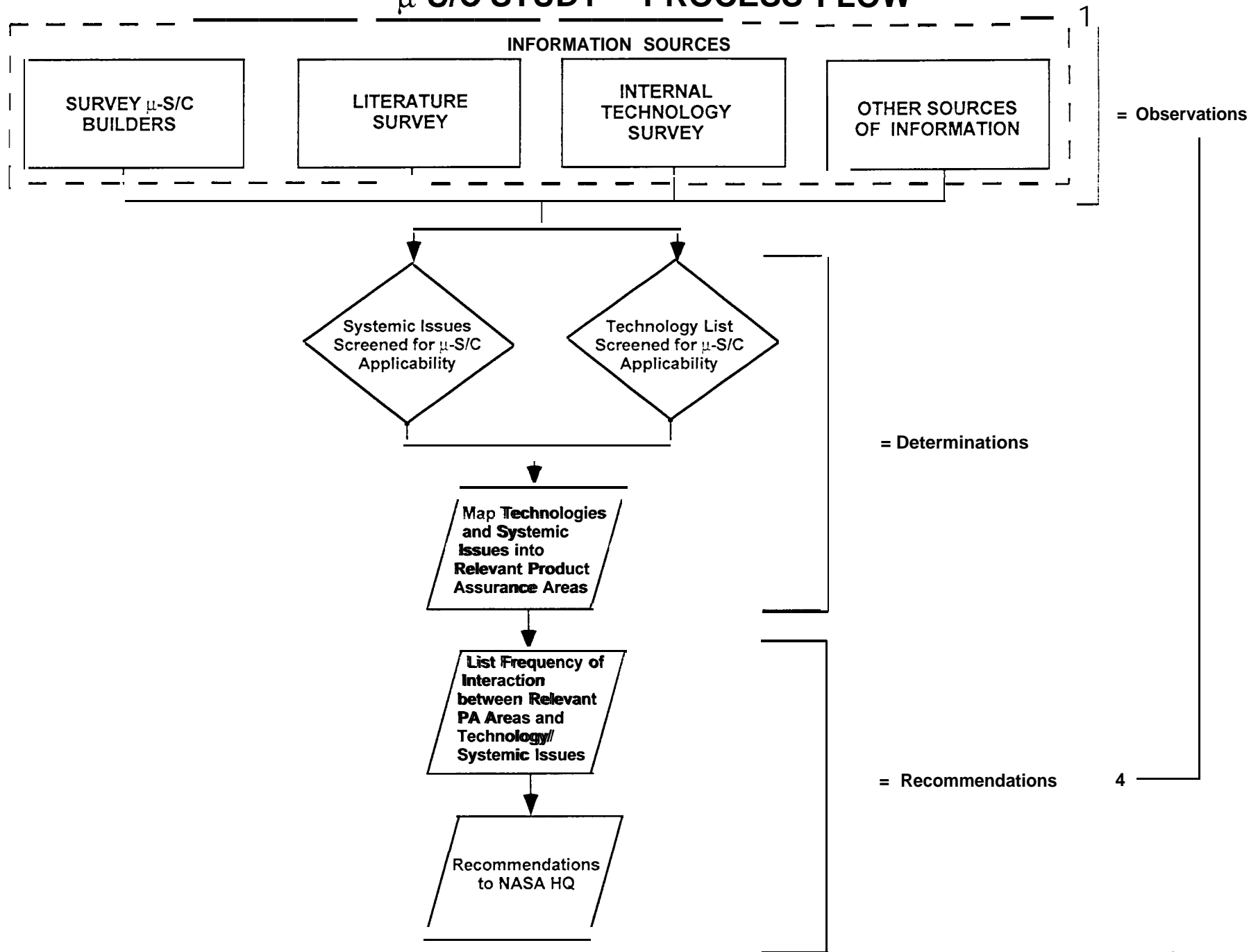
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MICROSPACECRAFT STUDY EFFORT

Why

- Determine existing state of microspacecraft development and status of mission assurance activity
- Identify mission assurance activities which enable acceleration of new technologies or improve schedule/cost
- Identify mission assurance roadblocks which retard progress and remove them or develop improvements

μ -S/C STUDY -- PROCESS FLOW



μ -S/C STUDY DETERMINATION

- Use of new technology is accelerating rapidly
- Product assurance technology assessments/implication should be periodically performed (-2 year centers)
- Technology insertion plan needed to establish degree of preflight assurance validation
- Known good die screening program for high reliability application needed
- Radiation data on commercial and advanced microelectronics needed
- Qualified MMICs and their packaging for telecommunications application is needed
- Manufacturing process critical parameter identification and control need development
- Applications for single build S/C with commercial off-the-shelf hardware needs to be understood
- μ -S/C unique QA methodologies need to be identified and developed
- Advanced packaging concepts need development to optimize mass to volume ratio for μ -S/C

μ -S/C STUDY DETERMINATION (cont.)

- **Special light weight materials qualification approaches need clarification**
- **Approach systematic design assessment for off-the-shelf hardware is needed**
- **New redundancy strategies for high reliability applications are needed for p-SiC**
- **New standards of reliability practice need to be established**
- **Long term storage efforts on μ -S/C hardware need to be understood**
- **Thermal reliability is altered by power and radiating area for μ -S/C. Implications need definition.**
- **Radiated emissions and susceptibility of μ -S/C are affected by new densities and geometry. Implications need definition.**
- **Environmental testing needs refocus to p-S/C issues and logistics**
- **Improved defect detection and prevention methods needed**

RECOMMENDATIONS

Product Element	Deliverable
<ul style="list-style-type: none"> • μ-S/C Requirements/Reduction Thrust • Risk/Requirements Trade-offs • Defect Detection/Prevention • Technology Insertion Plan/Process • Parts Radiation Data Base • MMIC Advanced Telecom Technology • Long Life/Long Term Storage • Critical Parameters Ident. and Control • Guidance & Control Technology Qual. • Test Bed Criteria for Minimal Building Hardware • Standard Interface Bus • Characterization of New Structural Materials 	<ul style="list-style-type: none"> • μ-S/C Product Assurance Guidelines • Report on process of reductions and conclusions rationale • Guidelines containing μ-S/C risk trade-off depictions • ACEQ methodology for application to μ-S/C • Cost trade-off matrices • Detailed technology insertion plan identifying technical status and required actions • Report on radiation data, recommended design approach, hardness methods • MMIC qualification methodology • List of advanced MMIC devices qualified • Qualification data on qualified MMICs • Guidelines for design and test to assure μ-S/C long life/storage adequacy • Methodology for utilizing identified critical parameters in manufacturing cycle • Qual. methodology for ring laser gyro, micro-machined gyro, interferomic gyro • Reporting containing approach for implementing reliability and environmental test concurrent with test bed development activity and criteria for validation status • Reporting containing recommended standard inst./test bed interfaces • List characterizing new technology and materials data for μ-S/C

μ-S/C SUMMARY

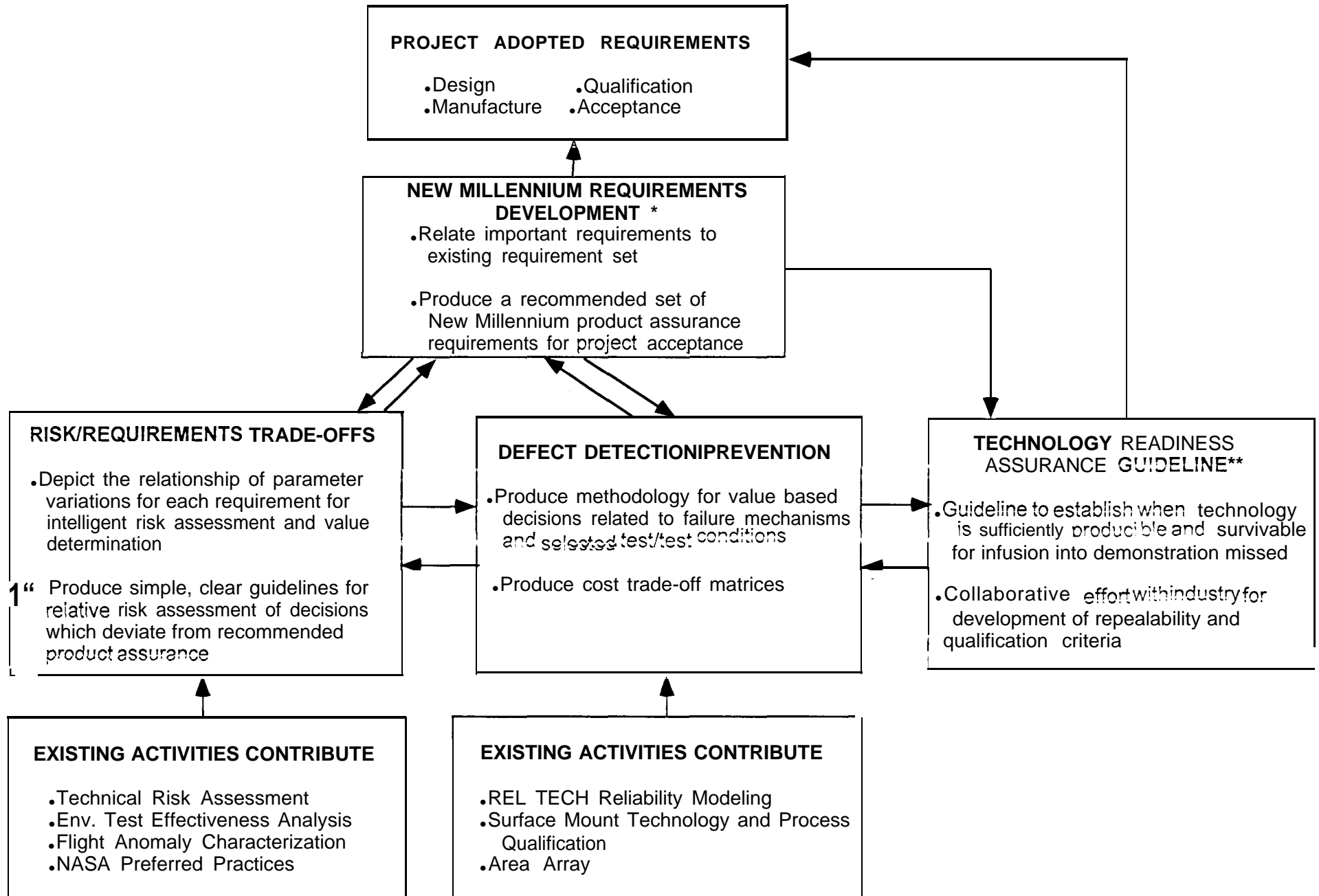
- . **Maximum leverage off of μ-S/C study recommendations is obtained by:**
 - . **Application of top 4 recommendations to New Millennium**
 - . **Quick start of these tasks**
 - . **Rapid delivery of products (cumulative)**
- . **Planned activity is collected into a Safety and Mission Assurance (Code Q) thrust for New Millennium**

•NEW MILLENNIUM MISSION ASSURANCE REQUIREMENTS

Additional Title Changes are:

<u>Recommended Title</u>		<u>New Name</u>
μ-S/C Requirements Reduction Thrust + New Millennium Requirements Development		
Risk Requirements Tradeoffs	→	No Change
Defect Detection/Prevention	→	No Change
Technology Insertion Plan/Process	→	Technology Readiness Assurance Guideline

NEW MILLENNIUM MISSION ASSURANCE REQUIREMENT



* Previously called μ -S/C Requirements Reduction, achieved through either elimination of existing requirements or project tailoring.

● *Previously called μ -S/C Technology Insertion Plan.

EXAMPLE OF REQUIREMENTS/VALUE/TRADEOFFS

New Millennium Requirements Development

- Design
- Manufacture
- Test
 - Dynamics
 - EMC
 - Thermal
 - Thermal Cycling
 - Thermal/Vacuum • 75° C. @ 144hr.
 - -200° C. @ 24 hr.
- Review

Resource/Capability Description
Alternative Solutions for Decisions

Recommended Mission Assurance Reqmts

Project Adopted Requirements

Technology Readiness Assurance Guidelines
Technical Content

Technology Qualification Guidelines

Operational & Mission Performance Tradeoffs Value (Relative) of Reqmts.

Physics of Failure Modes

	Money Comb	Graphite Structure	Gull Wings	
De'am.	X	X	-	-
Fatigue			X	-
Solder Failure			X	-

SENSITIVITY
INFORMATION REQUEST/CLARIFICATION

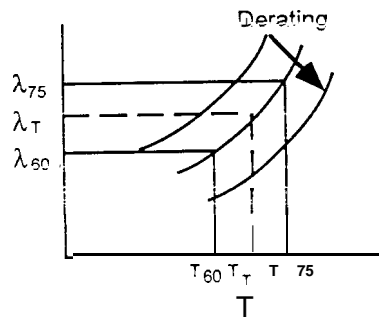
Risk/Reqmt. Tradeoff Thermal Vac

$$\lambda_T = Ae^{-\left[\left(\frac{E_a}{K} \frac{1}{T} - \frac{1}{T_0}\right)\right]}$$

Parameters of Th-Vac

Physics of Failure Detection

4



Test Temp = T_T assume 60° C.

For 60° C. to screen as 75° C. (Assume $\frac{\lambda_{75}}{\lambda_{60}} = 2$)

x Hrs. @ λ_{75} 144 Hrs. = 144 (2) = 288 Hrs. for equivalent stress f(t).
60 deg. C. (λ_{60})

AN ALTERNATIVE CAN BE DEVELOPED.

CAVEAT: PHYSICS OF FAILURE THRESHOLD EFFECT CAN BE AFFECTED BY LEVEL.

Defect/Detection/Prevention Failure Modes (Excited)

(PACTS)
Prevention/Analysis/Controls/Test

	Delamination	Solder Fatigue	Wire Bond Fail.	Lubricant Fail.	
Sine Vib	1	-	9	3	1.3
Th/Cyc	6	9	3		1.9
Th/Vac	9	6	3	9	1.2
Humidity	6				6
	1		3	6	1.0
	22	1	15	18	16

RELATIVE PERCEPTIVENESS BY TESTS OF DETECTION

RELATIVE VALUE OF TEST

SUMMARY

- . New technology and new concepts require new approaches**
- . Cost and schedule are major considerations, but quality and reliability must be maintained**
- . Succinct, clear, usable technical relationships must be articulated for understanding of value and content so project managers can make informed mission assurance decisions**
- . Less mission assurance can be of more value when the success achieved by cost effective and prudent risk taking is greater than the cost of failure**